



Highland Copper Announces Further Extension of Loan Maturity Date

August 14, 2020 – Longueuil, Quebec. Highland Copper Company Inc. (TSXV: HI, OTCQB: HDRSF) (the “Company”) announced today that the maturity date for the repayment of outstanding indebtedness under its credit agreement of US\$4,500,000 (the “Loan”) with Greenstone Resources II LP and Osisko Gold Royalties Ltd., was extended to August 31, 2020. Additional information about the Loan and previous extensions can be found in press releases of the Company, including those issued on May 21, 2019 and August 4, 2020.

About Highland

Highland Copper Company Inc. is a Canadian company focused on exploring and developing copper projects in the Upper Peninsula of Michigan, U.S.A. Information about the Company is available on SEDAR at www.sedar.com and on the Company’s website at www.highlandcopper.com.

Neither the TSX Venture Exchange nor its Regulation Services Provider (as that term is defined in the policies of the TSX Venture Exchange) accepts responsibility for the adequacy or accuracy of this release.

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